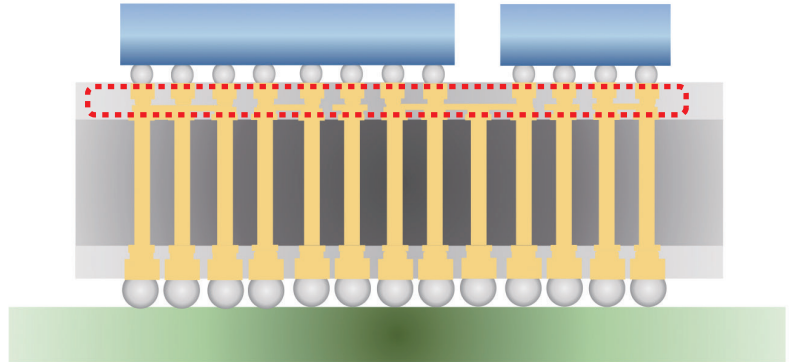
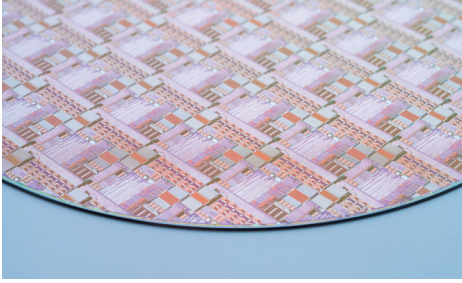
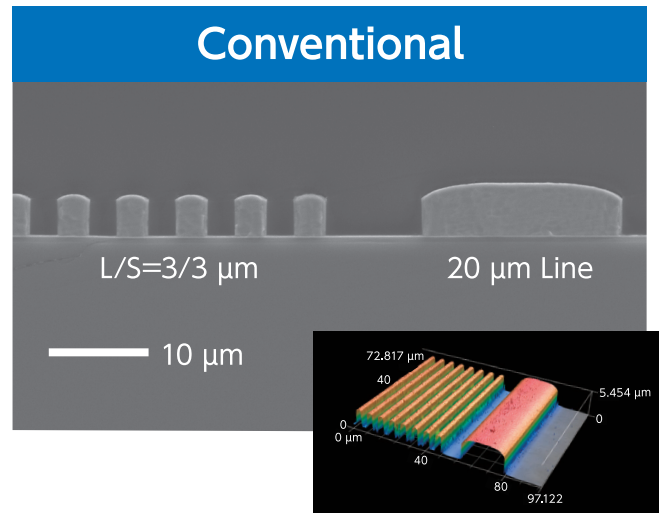
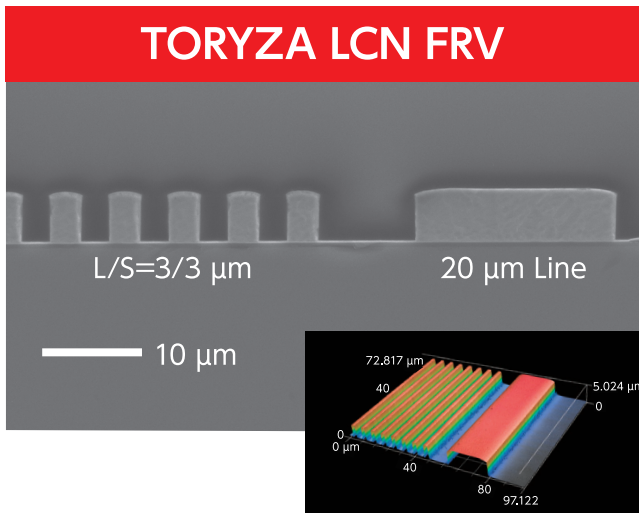


Acid copper plating additive for high filling performance and thickness uniformity

TORYZA LCN FRV

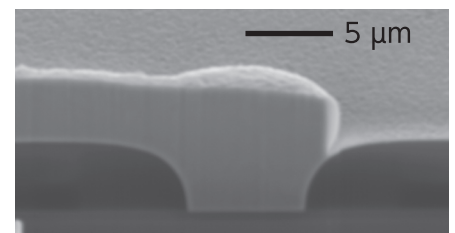
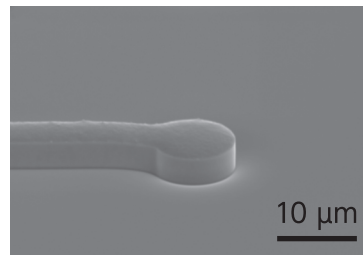
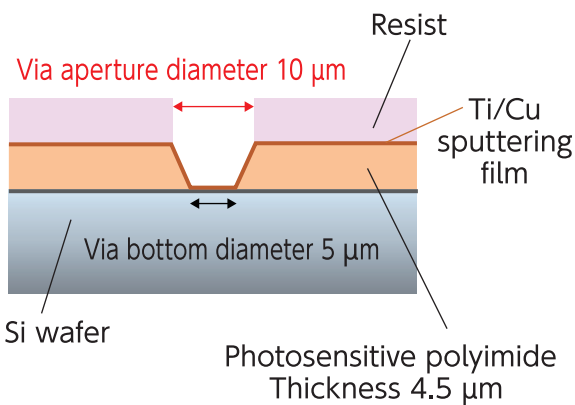


Can form square shape pattern uniformly



Current density 1.0 A/dm², surface thickness 5 μm

High filling performance into micro via



Current density 1.0 A/dm², surface thickness 5 μm